

## FLEXEM——IIoT HMI FE6000 Series

Module: FE6070C

## Overview

Flexem Industrial HMI 6000 Series, a new generation of IIoT human-machine interface. It is high-qu ality and cost-effective touch screen, industrial ABS plastic shell, low cost, high reliability. The main board is treated with a special coating (three anti-paint) to adapt to harsh environments.

The new model is with more practical down-line approach, and the redesigned front face has a better looking look, and higher resolution model is available.

By selecting the FLink IIoT module, you can upgrade to the IIoT human-machine interface immedia tely anduses complete and convenient industrial IIoT cloud platform service.

## **Appearance**









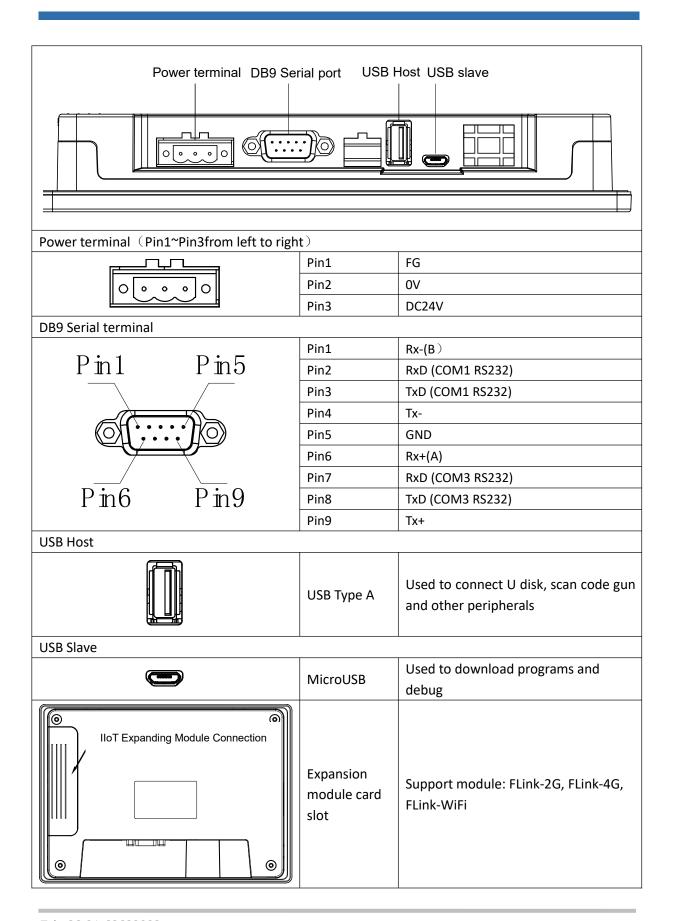


# **Specifications**

	Display	7" 16:9 TFT LCD
Hardware parameter	Resolution(WxH)	800×480
	Colors	24-bit
	Brightness	360 cd/m <sup>2</sup>
	Backlight	LED
	LCD Life	50000 hours
	Touch Panel	4 wires resistive touch screen
	CPU	600MHz ARM Cortex-A8
	Memory	128M Flash + 128M DDR3
	RTC	Built in
	Ethernet	NA
	USB Port	USB Slave 2.0 port*1,USB Host 2.0 port*1
	Download Project	USB Slave/U-disk
	COM Port	COM1:RS232/RS485/RS422
	CONTPOR	COM3:RS232
	LCD viewing angle (T/B/L/R)	50'/70'/70'
Electrical Specifications	Power Consumption	<10W
	Input Power	DC24V, working range DC 9V~28V
	Power Protection	Protected from thunderstrike and surging
	Power Down Allowed	<5mS
	07.0.5.110	Complied with EN61000-6-2:2005, EN61000-6-4:2007,
	CE & RoHS	RoHS, Surge Immunity: ±1KV, EFT: ±2KV,ESD:4KV, Air:8KV
Environment Specifications	Operating	0~50℃
	Temperature	
	Storage Temperature	-20~60℃
	Anti-UV	Not suitable to work in strong ultraviolet light (such as
		direct sunlight)
	Operating Humidity	10~90%RH(No condensation)
	Vibration Endurance	10~25Hz(X,Y,Z direction 2G/30 minutes)
	Cooling method	Natural air cooling
Mechanical Index	Degree of Protection	Front IP65(with NEMA panel),Back IP20
	Enclosure	Engineering plastic
	Panel Cutout(WxH)	192mm×138mm
	Dimension	204mm×145mm×33.8mm
	Weight	About 560g

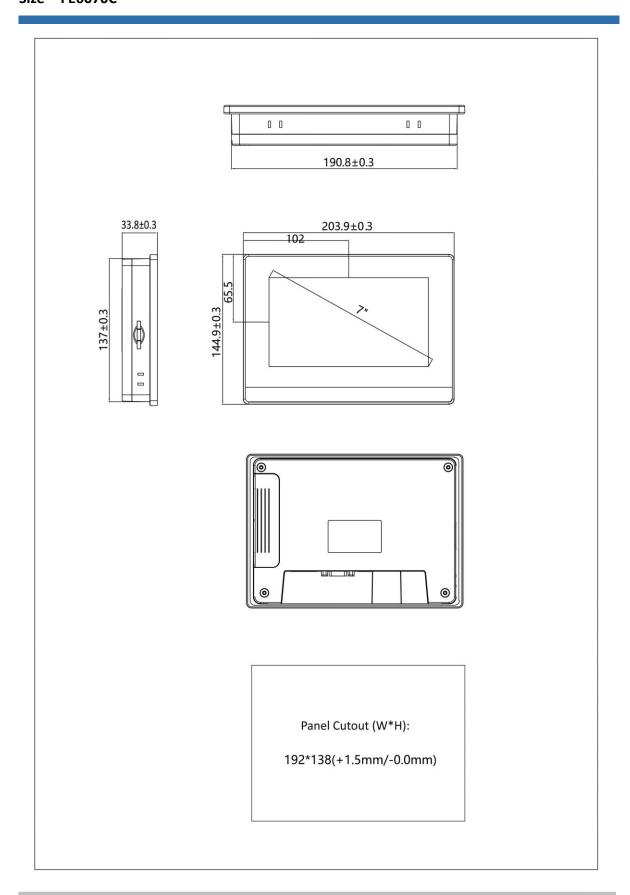
# Wiring definition





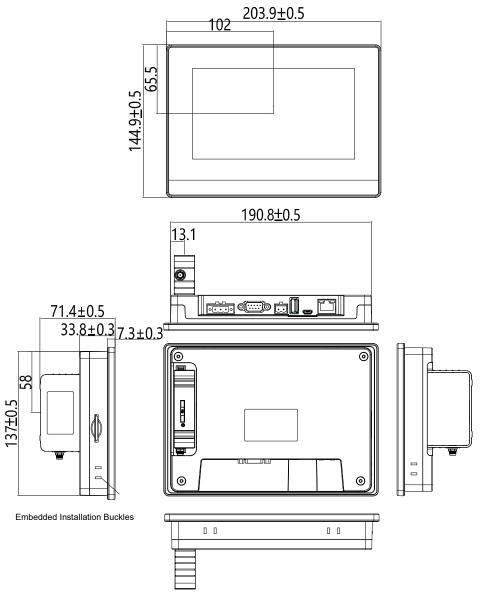


## Size FE6070C





## Size FE6070C+FLink



Panel Cutout of Embedded installation: 192mm\*138mm (+1.0/-0.0mm)



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